

**DATA SHEET** 

# AS193-000: PHEMT GaAs IC High-Linearity 3 V Control SPDT 0.1-2.5 GHz Switch Chip

#### **Features**

- 2.5 to 5 V linear operation
- Harmonics  $H_2$ ,  $H_3 < -65$  dBc @  $P_{IN} = 34.5$  dBm
- Low insertion loss (0.35 dB @ 0.9 GHz)
- High isolation (24 dB @ 0.9 GHz)
- · Lead (Pb)-free, RoHS-compliant, and Green

## **Description**

The AS193-000 is a PHEMT GaAs FET IC high-linearity SPDT switch. This switch has been designed for use where extremely high linearity, low control voltage, high isolation and low insertion loss are needed. Some standard implementations include antenna changeover, T/R and diversity switching over 3 W. The AS193-000 switch is ideal for GaAs based antenna switch front-end modules.





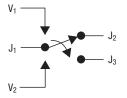
Skyworks Green™ products are RoHS (Restriction of Hazardous Substances)-compliant, conform to the EIA/EICTA/JEITA Joint Industry Guide (JIG) Level A guidelines, are halogen free according to IEC-61249-2-21, and contain <1,000 ppm antimony trioxide in polymeric materials.

# Electrical Specifications at 25 °C (0, 3 V)

Parameter <sup>(1)</sup>	Frequency	Min.	Тур.	Max.	Unit
Insertion loss <sup>(2)</sup>	0.1-0.5 GHz		0.30	0.4	dB
	0.5-1.0 GHz		0.35	0.5	dB
	1.0-2.0 GHz		0.45	0.6	dB
	2.0-2.5 GHz		0.55	0.7	dB
Isolation	0.1-0.5 GHz	28	30		dB
	0.5-1.0 GHz	22	24		dB
	1.0-2.0 GHz	17	19		dB
	2.0-2.5 GHz	15	17		dB
VSWR <sup>(3)</sup>	0.1-1.0 GHz		1.2:1		dB
	1.0-2.5 GHz		1.3:1		dB

- 1. All measurements made in a 50  $\Omega$  system, unless otherwise specified.
- 2. Insertion loss changes by 0.003 dB/°C.
- 3. Insertion loss state.

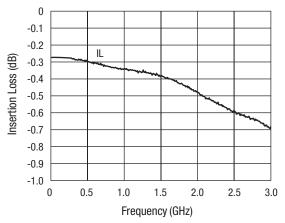
#### **Functional Block Diagram**



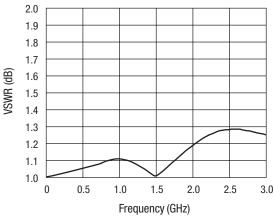
## Operating Characteristics at 25 °C (0, 3 V)

Parameter	Condition	Frequency	Min.	Тур.	Max.	Unit
Switching characteristics						
Rise, fall	10/90% or 90/10% RF			60		ns
On, off	50% CTL to 90/10% RF			100		ns
Video feedthru	$T_{RISE} = 1 \text{ ns}, BW = 500 \text{ MHz}$			50		mV
Input power for -0.1 dB compression	V <sub>CTL</sub> = 0/3 V	0.9 GHz		37		dBm
Harmonics H <sub>2</sub> , H <sub>3</sub>	$P_{IN} = 34.5 \text{ dBm}$	0.9 GHz		-65		dBc
Thermal resistance				25		°C/W
Control voltages	V <sub>LOW</sub> = 0 to 0.2 V @ 20 μA max. V <sub>HIGH</sub> = 2.5 V @ 50 μA max. to 5 V @ 100 μA max.					

## **Typical Performance Data**

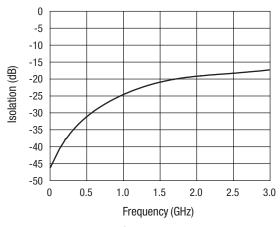


**Insertion Loss vs. Frequency** 

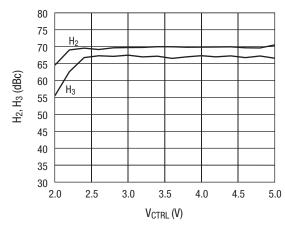


**VSWR vs. Frequency** 

Note: Contact factory for S-parameter data.



**Isolation vs. Frequency** 



 $\begin{aligned} & \text{Harmonics vs. Control Voltage} \\ & P_{\text{IN}} = 34.5 \text{ dBm, } 900 \text{ MHz, } \text{GSM Pulsed} \end{aligned}$ 

#### **Absolute Maximum Ratings**

Characteristic	Value			
RF input power	6 W max. > 900 MHz, 0/5 V control			
Control voltage	-0.2 V, +8 V			
Operating temperature	-40 °C to +85 °C			
Storage temperature	-65 °C to +150 °C			

Bond-pad metallization: gold. Backside metallization: none.

See application note, Handling GaAs MMIC Die.

Performance is guaranteed only under the conditions listed in the specifications table and is not guaranteed under the full range(s) described by the Absolute Maximum specifications. Exceeding any of the absolute maximum/minimum specifications may result in permanent damage to the device and will void the warranty.

CAUTION: Although this device is designed to be as robust as possible, ESD (Electrostatic Discharge) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions must be employed at all times.

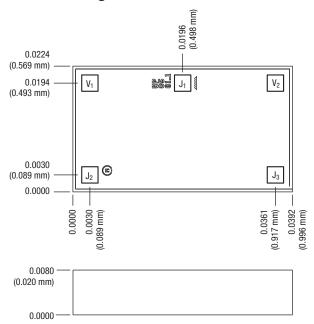
#### **Truth Table**

V <sub>1</sub>	V <sub>2</sub>	J <sub>1</sub> -J <sub>2</sub>	J <sub>1</sub> -J <sub>3</sub>	
0	$V_{HIGH}$	Isolation	Insertion loss	
V <sub>HIGH</sub>	0	Insertion loss	Isolation	

All other conditions not recommended.

 $V_{HIGH} = 2.5 \text{ to } 5 \text{ V}.$ 

### **Outline Drawing**



Chip thickness  $0.008 \pm 0.001$  (0.203  $\pm 0.025$ ).

Bond pad dimensions: 0.028 (0.07 mm square).

Bond pad metallization: gold.

Backside metallization: none.

Dimensions in inches (mm). Tolerance  $\pm$  0.001 (0.025 mm).

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